FR10MxIR

DC-10 RedLink® Fiber Optic Receiver

Data Sheet



DESCRIPTION

The Firecomms DC-10 MBd RedLink[®] receiver is a fully integrated photodiode and receiver IC. The receiver is housed in a miniature package to interface to plug-terminated lengths of Plastic Optic Fiber (POF) or 200 μ m Plastic Clad Silica (PCS) fiber. When paired with the appropriate transmitter, the receiver is capable of delivering 10 MBd digital signals over fiber and operate in the temperature range of -40 °C to +85 °C.

The connector is a robust optical to electrical receiver with integrated pulse width distortion minimization circuitry for reliable data transmission. It features a push-pull 5V TTL compatible CMOS output which is typically used at 10 MBd over POF in industrial automation serial bus protocols.



Firecomms

FEATURES

- Visible RCLED at red wavelength (650 nm)
- Optimized for data transmission from DC to 10 MBd
- Ideal for use with POF and PCS fiber
- Industrial temperature range -40 °C to +85 °C
- RoHS compliant and flame retardant (UL 94 V-0) connector housings
- Low pulse width distortion
- Compatible with Versatile Link cables and connectors
- Horizontal and Vertical options available
- 5 V Push Pull TTL Compatible CMOS output

AVAILABLE OPTIONS

| ORDERING INFORMATION / PART NUMBERS | | | | |
|--|----------|--|--|--|
| Inverting RedLink [®] 10 MBd Receiver Horizontal | FR10MHIR | | | |
| Inverting RedLink [®] 10 MBd Receiver Vertical | FR10MVIR | | | |
| Inverting RedLink [®] 10 MBd Receiver Tilte | FR10DWIR | | | |

Table 1

APPLICATIONS

| Table 2 APPLICATIONS | | | |
|-------------------------|--|--|--|
| Application | Automation and Industrial Control. Serial Communications. Voltage Isolation. | | |
| Standard | Serial RS232, RS485, CAN-Bus, MODBUS, Profibus | | |
| Distance | 50 meters Step Index POF $^{[1]}$ 300 meters with 200 μm PCS fiber $^{[1]}$ | | |
| Speed | DC to 10 MBd | | |

Note: 1. Depending on the installation conditions.

SPECIFICATIONS

Firecomms^{*}

| Table 3RECEIVER PIN DESCRIPTION | | | | |
|---------------------------------|-----------------|----------------|--|--|
| Pin | Name | Symbol | | |
| 1 | Receiver Output | V ₀ | | |
| 2 | Receiver Ground | Gnd | | |
| 3 | Receiver Vcc | Vcc | | |
| 4 | No Connect | N.C. | | |
| 5 | Retaining Pin | Gnd | | |
| 8 | Retaining Pin | Gnd | | |
| | | | | |



Table 4 REGULATORY COMPLIANCE

| Parameter | Symbol | Standard | Level |
|--|------------------|----------------------|------------------------|
| Electrostatic Discharge, Human Body Model (contact ESD) | HBM | Mil-STD-883 | Level 2 (4 kV) |
| Radiated Emissions Immunity | Vm ⁻¹ | IEC 61000-4-3 | 15 Vm ⁻¹ |
| UL Certification | UL | 94 V-0 Material | Files No. (Pending) |
| Storage Compliance | MSL | J-STD-020E | 2a (4 week floor life) |
| Restriction of Hazardous Substances Directive | RoHS | Directive 2011/65/EU | Certified compliant |

RECOMMENDED APPLICATION CIRCUIT



RedLink[®] Receiver Application Circuit

SPECIFICATIONS

FR10MxIR Revision A

| Table 5 | | | | | |
|----------|---------|---------|--|--|--|
| ABSOLUTE | MAXIMUM | RATINGS | | | |

These are the absolute maximum ratings at or beyond which the FOT can be expected to be damaged Notes: 1. 260 °C for 10 seconds, one time only, at least 2.2 mm away from lead root

| Parameter | Symbol | Minimum | Maximum | Unit | |
|--------------------------------------|------------------|---------|---------|------|--|
| Storage Temperature | T _{stg} | -40 | +85 | °C | |
| Operating Temperature | T _{op} | -40 | +85 | °C | |
| Soldering Temperature ^[1] | T _{sld} | | +260 | °C | |
| RX Supply Voltage | Vcc | -0.5 | +5.5 | V | |
| RX Output Current | I _O | -16 | +16 | mA | |



IGURE 4.

Receiver Propagation Delay and rise/fall time definitions

This Receiver has an output stage that is a standard CMOS push-pull design. It is suitable for operation with standard 5V CMOS logic IC's. It is not an open collector stage. It is not compatible with voltages higher than 5.5 V.



Receiver CMOS Push-Pull output stage.

SPECIFICATIONS

FR10MxIR Revision A

Table 6 RECEIVER ELECTRICAL AND OPTICAL CHARACTERISTICS

Test Conditions:

- 1. Test data was validated over the full temperature range of -40 °C to +85 °C, and over the full supply rail voltage of 4.5 V to 5.5 V. Data referred to as typical are rated at +25 °C and Vcc = 5.0 V.
- 2. Input power levels are for peak (not average) optical input levels. For 50% duty cycle data, peak optical power is twice the average optical power.
- 3. Receiver overdrive (PRL,max) is specified as the limit where |PWD| will not exceed 30 ns. The receiver will be in the correct state (logic "0") for optical powers above PRL,max. However, it may not meet a 30% symbol period PWD if the overdrive limit is exceeded.
- 4. Estimated value measured from junction to PC board solder joint for horizontal mount package.
- 5. Pins 5 and 8 are used for mounting and retaining purposes. It is required that pins 5 and 8 be connected to ground.
- 6. In recommended receiver circuit, with an optical signal from the recommended transmitter circuit.
- 7. Pin 4 is electrically isolated internally. Pin 4 may be externally connected to pin 1 for board layout compatibility with existing designs. Otherwise it is recommended pin 4 be grounded.
- 8. BER ≤ 10E-9

| Parameter | Symbol | Min | Typical | Max | Unit | Test Condition |
|--|---------------------|----------|---------|-----|-----------------|-------------------------------|
| Peak POF Sensitivity: Minimum Input for Logic "0" | P _{rl min} | -22 | | | dBm | 1 mm POF, PWD < 30 ns |
| Peak POF Overdrive Limit: Maximum Input for Logic "0" | P _{RL MAX} | | | +2 | dBm | 1 mm POF, PWD < 30 ns |
| Peak POF Off State Limit: Maximum Input for Logic "1" | P _{RH MAX} | | | -40 | dBm | 1 mm POF |
| Peak HCS Sensitivity: Minimum Input for Logic "0" | P _{rl min} | -24 | | | dBm + | 200 µm PCS, PWD < 30 ns |
| Peak HCS Overdrive Limit: Maximum Input for Logic "0" | P _{RL MAX} | | | 0 | dBm | 200 µm PCS, PWD < 30 ns |
| Peak HCS Off State Limit: Maximum Input for Logic "1" | P _{RH MAX} | | | -42 | dBm | 200 μm PCS |
| Supply Current | I _{cc} | | 13 | 16 | mA | V _o = Open Circuit |
| High Level Output Voltage | V _{OH} | Vcc -0.5 | | Vcc | V | I ₀ = -40 μA |
| Low Level Output Voltage | V _{OL} | | 0.1 | 0.2 | V | I ₀ = -1.6 mA |
| Output Rise Time (10% 90%) | t _{RISE} | 4 | 8 | 12 | ns | C _{LOAD} = 10 pF |
| Output Fall Time (10% 90%) | t _{FALL} | 4 | 8.5 | 13 | ns | C _{LOAD} = 10 pF |
| Power Supply Noise Immunity | PSNI | 0.1 | 0.4 | | V _{PP} | Sine Wave DC – 10 MHz |

MECHANICAL DATA, HORIZONTAL



FIGURE 5. Mechanical dimensions of the horizontal receivers and PCB footprint, which is a top view General dimensional tolerance is \pm 0.2 mm



FIGURE 6. Packing tube for Firecomms Horizontal RedLink® Receivers

MECHANICAL DATA, VERTICAL



FIGURE 7.

Mechanical dimensions of the vertical receivers and PCB footprint, which is a top view General dimensional tolerance is \pm 0.2 mm



FIGURE 8. Packing tube for Firecomms Vertical RedLink® Receivers

MECHANICAL DATA, 30° TILTED





FIGURE 9.

2.20 min.

PCB Hole Details

Top View

Mechanical dimensions of the tilted receiver connectors and PCB footprint, which is a top view General dimensional tolerance is ± 0.2 mm



17.72

19.3

Top View

FIGURE 10. Packing tube for Firecomms Tilted RedLink® Receivers

PART HANDLING

The Firecomms[™] high voltage RedLink[®] receiver devices are color coded blue. They are autoinsertable. They are tested for handling in static-controlled assembly processes (HBM). Cleaning, degreasing and post solder washing should be carried out using standard solutions compatible with both plastics and the environment. For example, recommended solutions for degreasing are alcohols (methyl, isopropyl and isobutyl). Acetone, ethyl acetate, phenol or similar solution based products are not permitted.

In the soldering process, non-halogenated water soluble fluxes are recommended. These parts are not suitable for use in reflow solder processes (infrared/vapor-phase reflow). The dust plug should remain in place during soldering, washing and drying processes to avoid contamination of the active optical area of each component.

The Moisture Sensitivity Level (MSL) classification of this device is 2a according to JEDEC J-STD-020E. The shelf life of an unopened MBB (Moisture Barrier Bag) is 24 months at < 40 °C and < 90 % R.H. Once the Moisture Barrier Bag is opened the devices can be either

- a) Stored in normal factory conditions < 30 °C and < 60 % R.H. for a maximum of 672 hours (4 Weeks) prior to soldering.
- b) Stored at < 10 % R.H. (Dry Cabinet).

PACKING INFORMATION

Components are packed in PVC anti-static tubes in moisture barrier bags. Bags should be opened only in static-controlled locations, and standard procedures should be followed for handling moisture sensitive components.

| | | Horizontal | Vertical |
|-----------------------------------|---------------------|------------|----------|
| Components per Tube | | 40 | 40 |
| | Tube Length | 515 mm | 515 mm |
| | Tube Height | 16.2 mm | 21.0 mm |
| | Tube Depth | 26.9 mm | 30.8 mm |
| Tubes per Bag | | 5 | 5 |
| Bags per Inner Carton | | 1 | 1 |
| | Inner Carton Length | 630 mm | 630 mm |
| | Inner Carton Width | 70 mm | 70 mm |
| | Inner Carton Height | 105 mm | 105 mm |
| Weight per Inner Carton, Complete | | 0.77 kg | 0.92 kg |
| Components per Inner Carton | | 200 | 200 |
| Inner Cartons per Outer Carton | | 10 | 10 |
| | Outer Carton Length | 650 mm | 650 mm |
| | Outer Carton Width | 235 mm | 235 mm |
| | Outer Carton Height | 376 mm | 376 mm |
| Weight per Outer Carton, Complete | | 8.14 kg | 9.61 kg |
| Components per Outer Carton | | 2,000 | 2,000 |

Table 7 PACKING INFORMATION

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